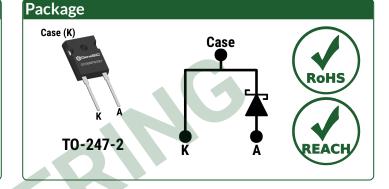
Silicon Carbide Schottky Diode



V <sub>RRM</sub> =	3300 V
<b>I</b> F(T <sub>C</sub> = 152°C) =	40 A
Qc =	429 nC

#### Features

- Enhanced Surge and Avalanche Robustness
- Low V<sub>F</sub> for High Temperature Operation
- Superior Figure of Merit Q<sub>C</sub>/I<sub>F</sub>
- Low Thermal Resistance
- Low Reverse Leakage Current
- Temperature Independent Fast Switching
- Positive Temperature Coefficient of V<sub>F</sub>
- High dV/dt Ruggedness



#### Advantages

- High System Reliability
- Optimal Price Performance
- Improved System Efficiency
- Reduced Cooling Requirements
- Increased System Power Density
- Zero Reverse Recovery Current
- Easy to Parallel without Thermal Runaway
- Enables Extremely Fast Switching

### Applications

- EV Fast Chargers
- 1500V Solar Inverters
- Pulsed Power
- HVDC and Grid-Converters
- Industrial Power Supply
- Motor Traction
- Medical Imaging
- High Voltage Converters

Absolute Maximum Ratings (At T <sub>c</sub> = 25°C Unl	ess Otherwise	e Stated)			
Parameter	Symbol	Conditions	Values	Unit	Note
Repetitive Peak Reverse Voltage	V <sub>RRM</sub>		3300	V	
		T <sub>C</sub> = 100°C, D = 1	75		
Continuous Forward Current	IF	T <sub>C</sub> = 135°C, D = 1	54	А	Fig. 4
		T <sub>C</sub> = 152°C, D = 1	40		
Non-Repetitive Peak Forward Surge Current, Half Sine	I	T <sub>C</sub> = 25°C, t <sub>P</sub> = 10 ms	500	٨	
Wave	IF,SM	T <sub>C</sub> = 150°C, t <sub>P</sub> = 10 ms	400	A	
Panatitive Paak Forward Surge Current, Half Sine Waye	1	T <sub>C</sub> = 25°C, t <sub>P</sub> = 10 ms	300	Δ.	
Repetitive Peak Forward Surge Current, Half Sine Wave	I <sub>F,RM</sub>	T <sub>C</sub> = 150°C, t <sub>P</sub> = 10 ms	210	A	
Non-Repetitive Peak Forward Surge Current	I <sub>F,MAX</sub>	T <sub>C</sub> = 25°C, t <sub>P</sub> = 10 μs	2500	А	
i <sup>2</sup> t Value	∫i²dt	T <sub>C</sub> = 25°C, t <sub>P</sub> = 10 ms	1250	A <sup>2</sup> s	
Non-Repetitive Avalanche Energy	E <sub>AS</sub>	L = 1.2 mH, I <sub>AS</sub> = 40 A	1000	mJ	
Diode Ruggedness	dV/dt	V <sub>R</sub> = 0 ~ 2640 V	200	V/ns	
Power Dissipation	Ртот	T <sub>C</sub> = 25°C	944	W	Fig. 3
Operating and Storage Temperature	Tj, Tstg		-55 to 175	°C	



## Electrical Characteristics

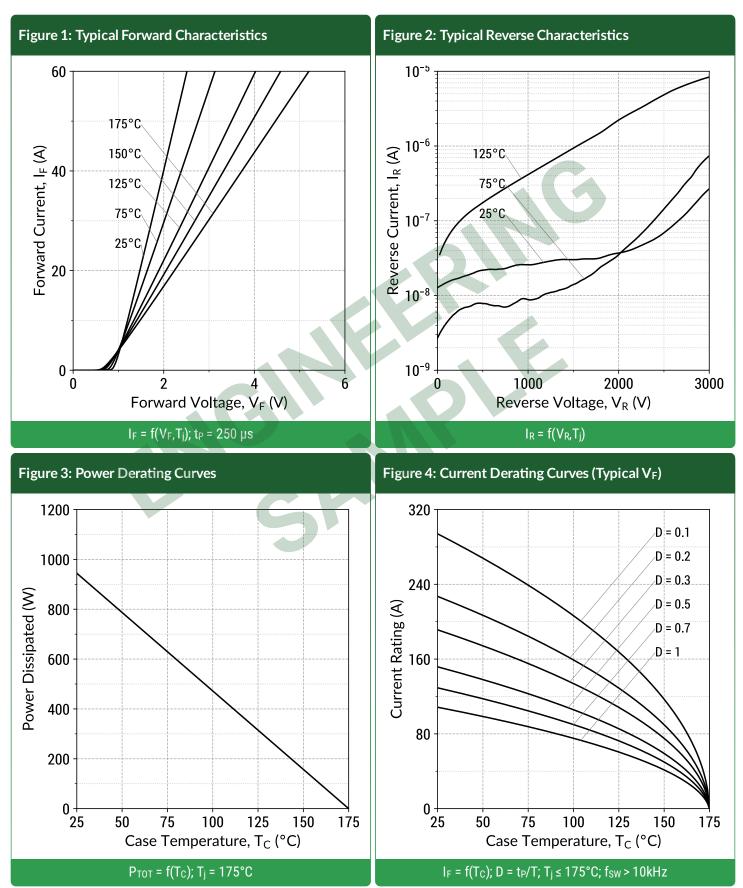
					Values			
Parameter	Symbol	Conditions		values			Unit	Note
				Min.	Тур.	Max.		inote
Diado Forward Voltago	VF	I <sub>F</sub> = 40 A, T <sub>j</sub> = 25°C			1.95	2.5	V	Fig. 1
Diode Forward Voltage	VF	I <sub>F</sub> = 40 A, T <sub>j</sub>		3.7		v		
Reverse Current		V <sub>R</sub> = 3300 V,		10	100		Fig. 2	
	IR	V <sub>R</sub> = 3300 V, <sup>-</sup>		200		μA		
Total Capacitive Charge	0.		V <sub>R</sub> = 1500 V		399		20	Fig. 7
	Qc	I <sub>F</sub> ≤ I <sub>F,MAX</sub>	V <sub>R</sub> = 1700 V		429		nC	Fig. 7
Switching Time	+-	dl <sub>F</sub> /dt = 200 A/µs V <sub>R</sub> = 1500 V			< 10		ns	
	ts		V <sub>R</sub> = 1700 V		× 10	115		
Total Canacitanaa	0	V <sub>R</sub> = 1 V, f = 1MHz			3480		ъĘ	Fig. 6
Total Capacitance	С	V <sub>R</sub> = 1700 V,		150		pF		

### Thermal/Package Characteristics

Deremeter	Symbol		Conditions	Values			Umit	Nata
Parameter		Conditions	Min.	Тур.	Max.	Unit	Note	
Thermal Resistance, Junction - Case	RthJC				0.16		°C/W	Fig. 9
Weight	WT				6.0		g	
Mounting Torque	Тм		Screws to Heatsink			1.1	Nm	

CAN

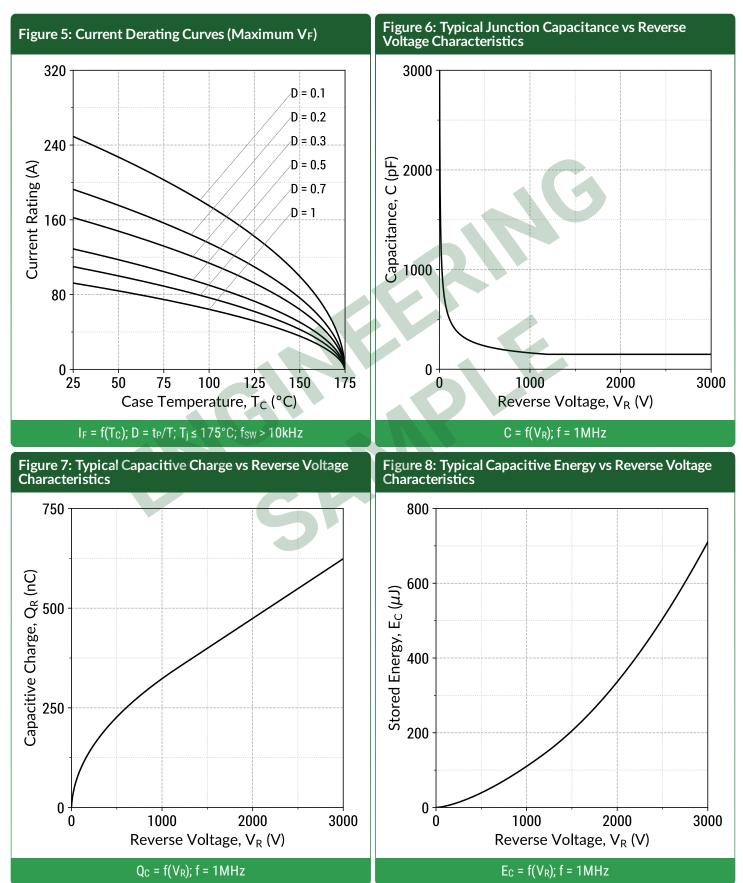




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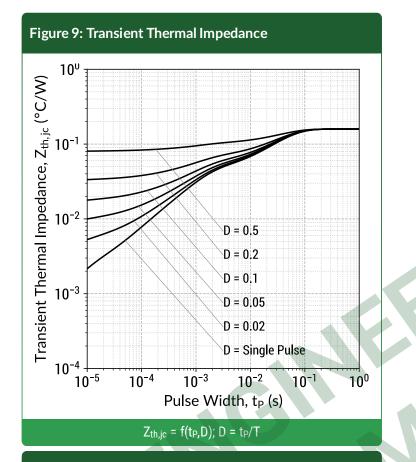
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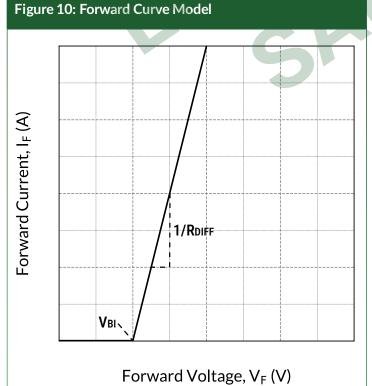




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 $I_F = f(V_F,T_j)$ 

### Forward Curve Model Equation:

 $I_F = (V_F - V_{BI})/R_{DIFF} (A)$ 

Built-In Voltage (V<sub>BI</sub>):

$$V_{BI}(T_j) = m \times T_j + n (V)$$
  
m = -0.0013 (V/°C)  
n = 0.997 (V)

Differential Resistance (RDIFF):

 $\begin{aligned} & \mathsf{R}_{\mathsf{DIFF}}(\mathsf{T}_j) = \mathbf{a} \times \mathsf{T}_j^2 + \mathbf{b} \times \mathsf{T}_j + \mathbf{c} \ (\Omega) \\ & \mathbf{a} = 9.35 \text{e-} 07 \ (\Omega/^\circ \text{C}^2) \\ & \mathbf{b} = 0.000134 \ (\Omega/^\circ \text{C}) \\ & \mathbf{c} = 0.0219 \ (\Omega) \end{aligned}$ 

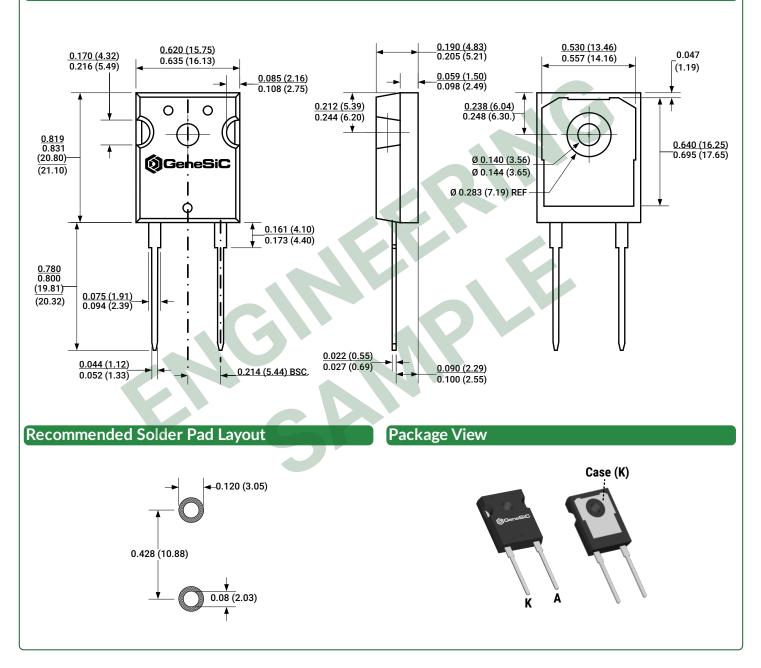
Forward Power Loss Equation:

 $P_{LOSS} = V_{BI}(T_j) \times I_{AVG} + R_{DIFF}(T_j) \times I_{RMS}^2$ 



### Package Dimensions

### TO-247-2 Package Outline



#### NOTE

- 1. CONTROLLED DIMENSION IS INCH. DIMENSION IN BRACKET IS MILLIMETER.
- 2. DIMENSIONS DO NOT INCLUDE END FLASH, MOLD FLASH, MATERIAL PROTRUSIONS.

## GC50MPS33H 3300V 40A SiC Schottky MPS™ Diode



### Compliance

#### **RoHS Compliance**

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS 2), as adopted by EU member states on January 2, 2013 and amended on March 31, 2015 by EU Directive 2015/863. RoHS Declarations for this product can be obtained from your GeneSiC representative.

#### **REACH Compliance**

REACH substances of high concern (SVHCs) information is available for this product. Since the European Chemical Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, please contact a GeneSiC representative to insure you get the most up-to-date REACH SVHC Declaration. REACH banned substance information (REACH Article 67) is also available upon request.

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### **Related Links**

SPICE Models:	https://www.genesicsemi.com/sic-schottky-mps/GC50MPS33H/GC50MPS33H_SPICE.zip
• PLECS Models:	https://www.genesicsemi.com/sic-schottky-mps/GC50MPS33H/GC50MPS33H_PLECS.zip
• CAD Models:	https://www.genesicsemi.com/sic-schottky-mps/GC50MPS33H/GC50MPS33H_3D.zip
• Evaluation Boards	: https://www.genesicsemi.com/technical-support
<ul> <li>Reliability:</li> </ul>	https://www.genesicsemi.com/reliability
<ul> <li>Compliance:</li> </ul>	https://www.genesicsemi.com/compliance
• Ouality Manual:	https://www.genesicsemi.com/guality

#### **Revision History**

Rev 21/Jun: Initial Release



### www.genesicsemi.com/sic-schottky-mps/



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